

N-Channel Enhancement-Mode Vertical DMOS FET

Features

- Free from Secondary Breakdown
- Low Power Drive Requirement
- Ease of Paralleling
- Low C_{ISS} and Fast Switching Speeds
- Excellent Thermal Stability
- Integral Source-Drain Diode
- High Input Impedance and High Gain

Applications

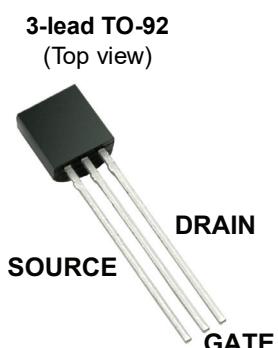
- Motor Controls
- Converters
- Amplifiers
- Switches
- Power Supply Circuits
- Drivers (Relays, Hammers, Solenoids, Lamps, Memory, Displays, Bipolar Transistors, etc.)

General Description

The 2N7000 is an Enhancement-mode (normally-off) transistor that uses a vertical DMOS structure and a well-proven silicon gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors as well as the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally induced secondary breakdown.

Microchip's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Type



See [Table 3-1](#) for pin information.

2N7000

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

Drain-to-Source Voltage	BV _{DSS}
Drain-to-Gate Voltage	BV _{DGS}
Gate-to-Source Voltage	±30V
Operating Ambient Temperature, T _A	-55°C to +150°C
Storage Temperature, T _S	-55°C to +150°C

† **Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

Electrical Specifications: T_A = 25°C unless otherwise specified. All DC parameters are 100% tested at 25°C unless otherwise stated. (Pulse test: 300 µs pulse, 2% duty cycle)

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Drain-to-Source Breakdown Voltage	BV _{DSS}	60	—	—	V	V _{GS} = 0V, I _D = 10 µA
Gate Threshold Voltage	V _{GS(th)}	0.8	—	3	V	V _{GS} = V _{DS} , I _D = 1 mA
Gate Body Leakage Current	I _{GSS}	—	—	10	nA	V _{GS} = ±15V, V _{DS} = 0V
Zero-Gate Voltage Drain Current	I _{DSS}	—	—	1	µA	V _{GS} = 0V, V _{DS} = 48V
		—	—	1	mA	V _{GS} = 0V, V _{DS} = 48V, T _A = 125°C (Note 1)
On-State Drain Current	I _{D(ON)}	75	—	—	mA	V _{GS} = 4.5V, V _{DS} = 10V
Static Drain-to-Source On-State Resistance	R _{D(ON)}	—	—	5.3	Ω	V _{GS} = 4.5V, I _D = 75 mA
		—	—	5	Ω	V _{GS} = 10V, I _D = 500 mA

Note 1: Specification is obtained by characterization and is not 100% tested.

AC ELECTRICAL CHARACTERISTICS

Electrical Specifications: T_A = 25°C unless otherwise specified. All AC parameters are not 100% sample tested.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Forward Transconductance	G _{FS}	100	—	—	mmho	V _{DS} = 10V, I _D = 200 mA
Input Capacitance	C _{ISS}	—	—	60	pF	V _{GS} = 0V, V _{DS} = 25V, f = 1 MHz
Common-Source Output Capacitance	C _{OSS}	—	—	25	pF	
Reverse Transfer Capacitance	C _{RSS}	—	—	5	pF	
Turn-On Delay Time	t _{d(ON)}	—	—	10	ns	V _{DD} = 15V, I _D = 500 mA, R _{GEN} = 25Ω
Turn-Off Delay Time	t _{d(OFF)}	—	—	10	ns	
DIODE PARAMETER						
Diode Forward Voltage Drop	V _{SD}	—	0.85	—	V	V _{GS} = 0V, I _{SD} = 200 mA (Note 1)

Note 1: All DC parameters are 100% tested at 25°C unless otherwise stated.

(Pulse test: 300 µs pulse, 2% duty cycle)

TEMPERATURE SPECIFICATIONS

Electrical Characteristics: Unless otherwise specified, for all specifications $T_A = T_J = +25^\circ\text{C}$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
TEMPERATURE RANGE						
Operating Ambient Temperature	T_A	-55	—	+150	°C	
Storage Temperature	T_S	-55	—	+150	°C	
PACKAGE THERMAL RESISTANCE						
3-lead TO-92	θ_{JA}	—	132	—	°C/W	

Note 1: Mounted on an FR4 board; 25 mm x 25 mm x 1.57 mm

THERMAL CHARACTERISTICS

Package	I_D (Note 1) (Continuous) (mA)	I_D (Pulsed) (mA)	Power Dissipation at $T_C = 25^\circ\text{C}$ (W)	I_{DR} (Note 1) (mA)	I_{DRM} (mA)
3-lead TO-92	200	500	1	200	500

Note 1: I_D (continuous) is limited by maximum T_J .

2N7000

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g. outside specified power supply range) and therefore outside the warranted range.

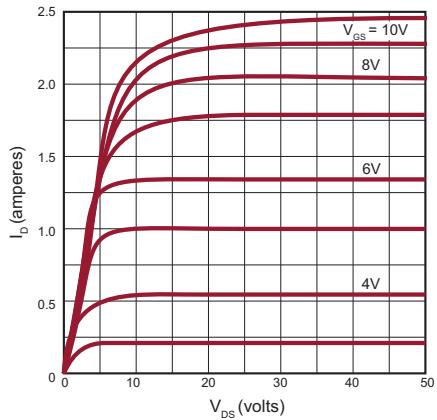


FIGURE 2-1: Output Characteristics.

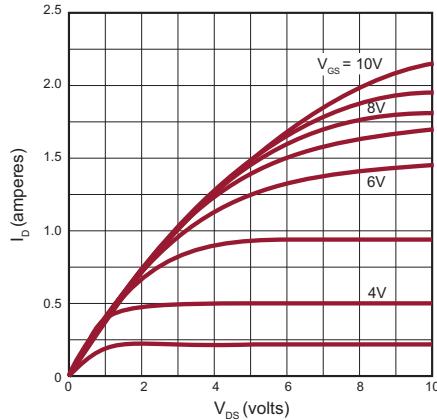


FIGURE 2-4: Saturation Characteristics.

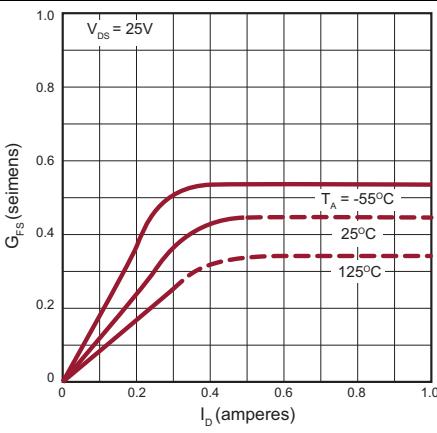


FIGURE 2-2: Transconductance vs. Drain Current.

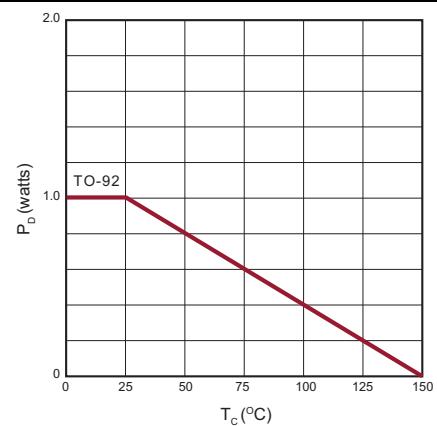


FIGURE 2-5: Power Dissipation vs. Case Temperature.

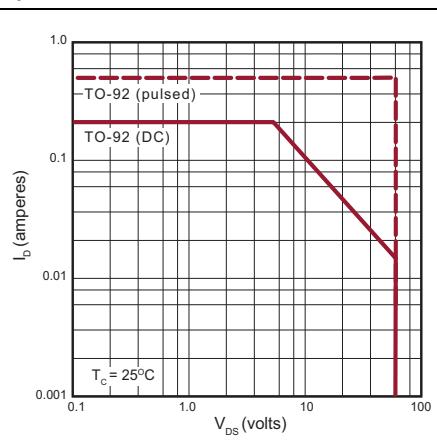


FIGURE 2-3: Maximum Rated Safe Operating Area.

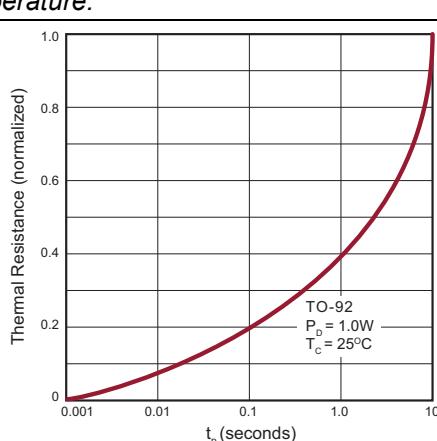


FIGURE 2-6: Thermal Response Characteristics.

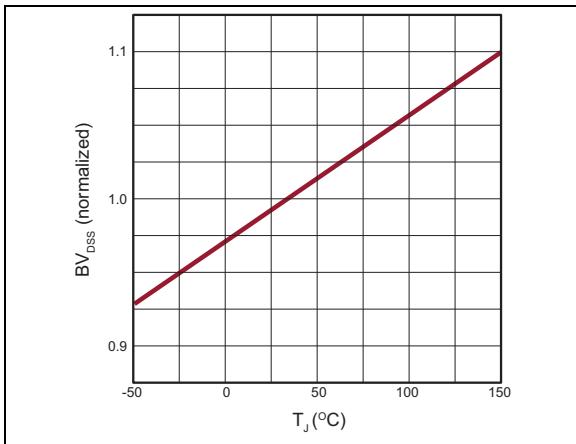


FIGURE 2-7: BV_{DSS} Variation with Temperature.

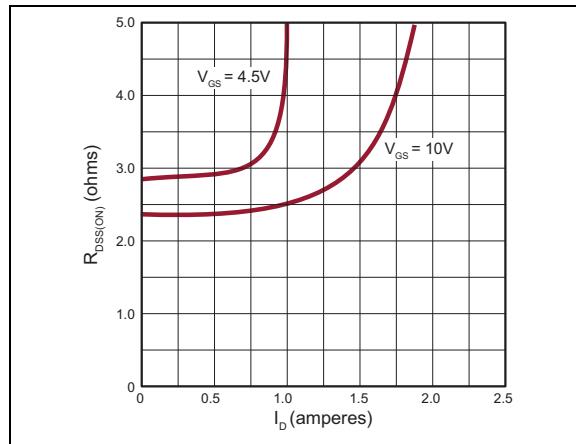


FIGURE 2-10: On-Resistance vs. Drain Current.

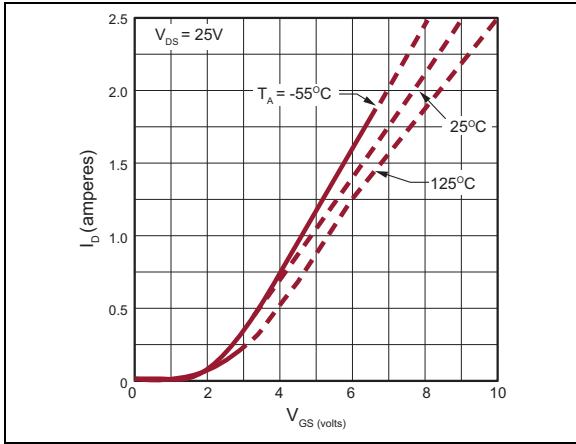


FIGURE 2-8: Transfer Characteristics.

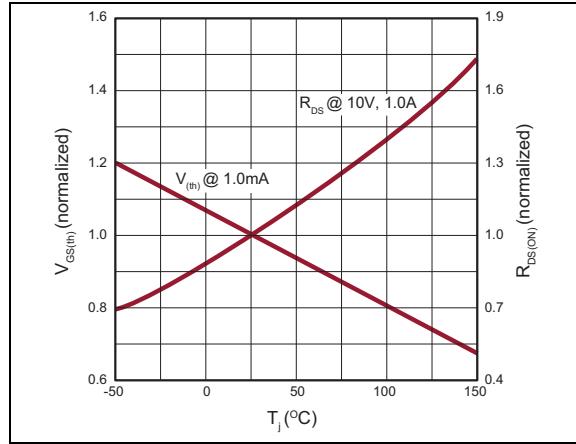


FIGURE 2-11: $V_{GS(th)}$ and R_{DS} Variation with Temperature.

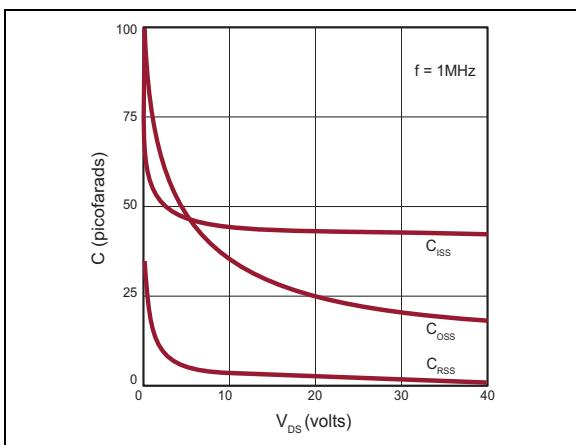


FIGURE 2-9: Capacitance vs. Drain-to-Source Voltage.

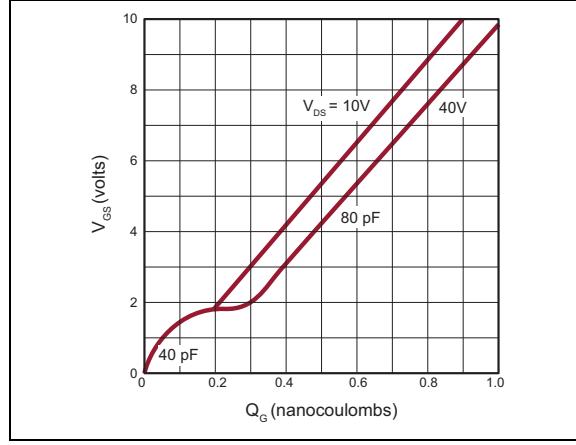


FIGURE 2-12: Gate Drive Dynamic Characteristics.

2N7000

3.0 PIN DESCRIPTION

Table 3-1 shows the description of pins in 2N7000.
Refer to [Package Type](#) for the location of the pins.

TABLE 3-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	Source	Source
2	Gate	Gate
3	Drain	Drain

4.0 FUNCTIONAL DESCRIPTION

Figure 4-1 illustrates the switching waveforms and test circuit for 2N7000.

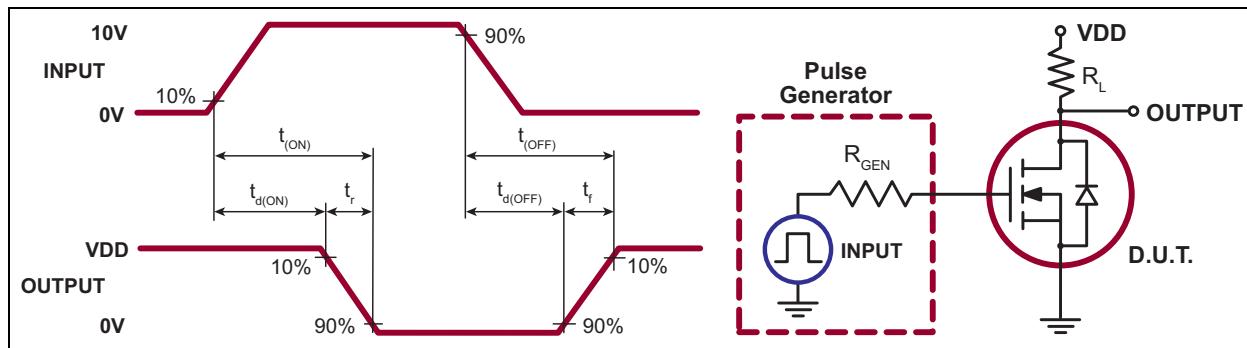


FIGURE 4-1: Switching Waveforms and Test Circuit.

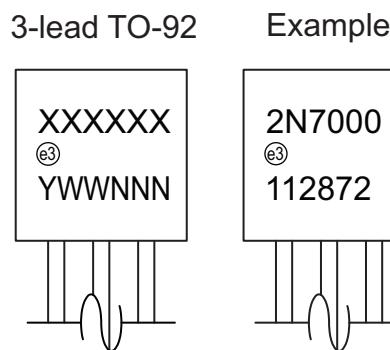
TABLE 4-1: PRODUCT SUMMARY

BV_{DSS}/BV_{DGS} (V)	$R_{DS(ON)}$ (Maximum) (Ω)	$V_{GS(th)}$ (Maximum) (mA)
60	5	75

2N7000

5.0 PACKAGING INFORMATION

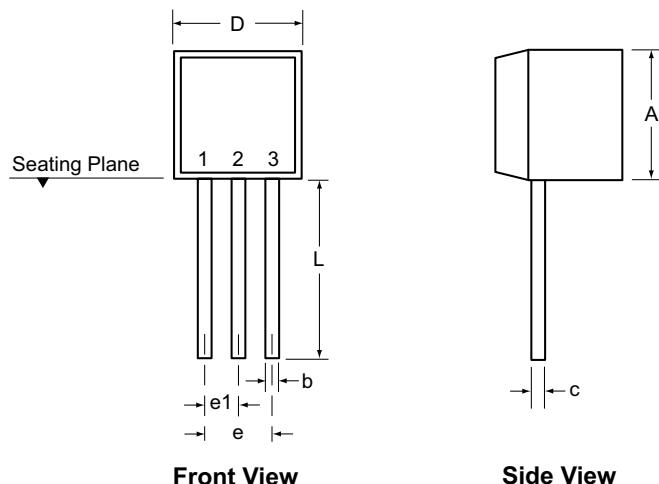
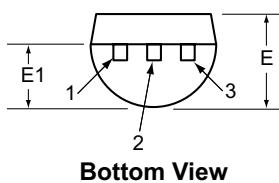
5.1 Package Marking Information



Legend:	
XX...X	Product Code or Customer-specific information
Y	Year code (last digit of calendar year)
YY	Year code (last 2 digits of calendar year)
WW	Week code (week of January 1 is week '01')
NNN	Alphanumeric traceability code
(e3)	Pb-free JEDEC® designator for Matte Tin (Sn)
*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
(e4)	Pre-plated

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.

3-Lead TO-92 Package Outline (L/LL/N3)

**Front View****Side View****Bottom View**

Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Symbol		A	b	c	D	E	E1	e	e1	L
Dimensions (inches)	MIN	.170	.014 ^t	.014 ^t	.175	.125	.080	.095	.045	.500
	NOM	-	-	-	-	-	-	-	-	-
	MAX	.210	.022 ^t	.022 ^t	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.

* This dimension is not specified in the JEDEC drawing.

^t This dimension differs from the JEDEC drawing.

Drawings not to scale.

2N7000

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (February 2021)

- Converted Supertex Doc# DSFP-2N7000 to Microchip D20005695A
- Removed the TO-92 N3 P002, P003, P005, P013, and P014 media types to align package specifications with the actual BQM
- Made minor text changes throughout the document

2N7000

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	XX	-	X	-	X	Examples:
Device	Package Options		Environmental	Media	Type	
Device: 2N7000 = N-Channel Enhancement-Mode Vertical DMOS FET						
Package:	(blank)	=	3-lead TO-92			
Environmental:	G	=	Lead (Pb)-free/RoHS-compliant Package			
Media Type:	(blank)	=	1000/Bag for a 3-lead TO-92 Package			

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